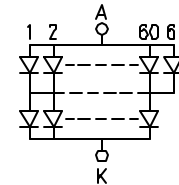


ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ PER MODULE $I_f=605\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		4.2	4.6	V_f	
REVERSE VOLTAGE	8			V_r	$V_r=0.2\text{mA}$
LUMINOUS INTENSITY		195		cd/m^2	$I_f=605\text{mA}$
EMITTED COLOR:	GREEN				
REFLECTOR FINISH:	WHITE				

LIMITS OF SAFE OPERATION AT 25°C PER MODULE

PARAMETER	MAX	UNITS
STEADY CURRENT	1520	mA
POWER DISSIPATION	7	W
DERATE FROM 25°C , PER DIE	-1.2	$\text{mW}/^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY		3 SEC. MAX



2 CHIPS IN SERIES
60 PARALLEL BRANCHES +1

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION -0.00 MAX.= +0.00 -DECIMAL PRECISION

REV.

PART NUMBER

SSB-COB7575GW

CONFIDENTIAL INFORMATION

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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75mm x 75mm V.A. CHIP ON BOARD LED BACKLIGHT,

565nm GREEN, 121 CHIPS, 4.2v @ 605mA.

DRAWN BY:

BC

CHECKED BY:

APPROVED BY:

DATE: 7.1.04

PAGE: 1 OF 1

SCALE: N/A